1-534998-2 ACTIVE

AMPMODU | Modu Connector System

TE Internal #: 1-534998-2

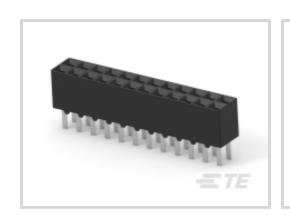
PCB Mount Receptacle, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu

Connector System

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Dielectric Withstanding Voltage (Max)

Insulation Resistance

Number of Positions: 24

Number of Rows: 2

Features

Product Type Features

Applied Pressure

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	24
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	

Standard

750 VAC

 $5000~\mathrm{M}\Omega$



Operating Voltage	333 VAC
Body Features	
Connector Profile	Low
Primary Product Color	Black
Contact Features	
Contact Protection Type	Closed Entry Housing
Contact Mating Area Length	3.77 mm[.148 in]
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3.81 – 7.61 µm
Contact Shape & Form	Round
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	2 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.7 mm[.028 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Connector Height	5.03 mm[.198 in]



Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9.02 mm[.355 in]
PCB Thickness (Recommended)	1.57 mm[.055 – .094 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Compatible With Approved Standards Products	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	

18

Box, Tube

Product Compliance

Packaging Quantity

Packaging Type

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent



chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Also in the Series | Modu Connector System

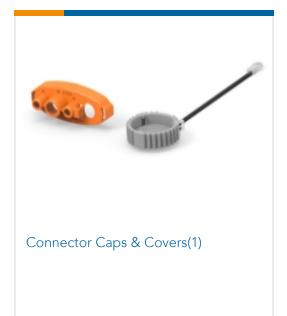




Automotive Housings(1)



Board-to-Board Jumpers & Shunts(5)







Connector Hardware(4)

PCB Headers & Receptacles(1244)

Standard Edge Connectors(2)

Customers Also Bought

PCB Mount Receptacle, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System





TE Part #1-5747872-6 15 PLUG SP/FMS INSRT



TE Part #3-794682-8
08P MICRO MNL ASSY,VRT,THRU,LF



TE Part #1934218-1
Tin Man Recept Assy 5 pair 8 Column



TE Part #3-794682-4 04P MICRO MNL ASSY,VRT,THRU,LF



TE Part #3-794682-2 02P MICRO MNL ASSY,VRT,THRU,LF



TE Part #5-87589-3 14 MODII HDR DRST SHRD .100CL



TE Part #103638-2 03 MTE HDR SRST LATCH .100CL



TE Part #534206-7 14 MODII VRT DR CE 100/115



TE Part #5-2176363-6 RQ 0402 1K62 0.1% 10PPM 5K RL



Documents

Product Drawings

24 MODIV VRT DR CE 100/125

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-534998-2_R.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-534998-2_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-534998-2_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

PCB Mount Receptacle, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System



Application Specification

English